



Welcome to [E-XFL.COM](https://www.e-xfl.com)

### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

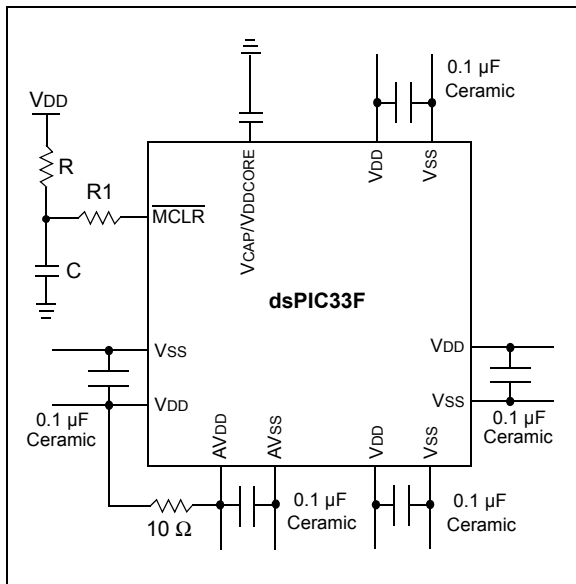
### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Active
Core Processor	dsPIC
Core Size	16-Bit
Speed	40 MIPs
Connectivity	CANbus, I <sup>2</sup> C, IrDA, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, DMA, Motor Control PWM, POR, PWM, QEI, WDT
Number of I/O	85
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	16K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 3.6V
Data Converters	A/D 24x10/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TQFP
Supplier Device Package	100-TQFP (14x14)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj64mc710-i-pf">https://www.e-xfl.com/product-detail/microchip-technology/dspic33fj64mc710-i-pf</a>

# dsPIC33FJXXXMCX06/X08/X10

**FIGURE 2-1: RECOMMENDED MINIMUM CONNECTION**



## 2.2.1 TANK CAPACITORS

On boards with power traces running longer than six inches in length, it is suggested to use a tank capacitor for integrated circuits including DSCs to supply a local power source. The value of the tank capacitor should be determined based on the trace resistance that connects the power supply source to the device, and the maximum current drawn by the device in the application. In other words, select the tank capacitor so that it meets the acceptable voltage sag at the device. Typical values range from 4.7  $\mu\text{F}$  to 47  $\mu\text{F}$ .

## 2.3 Capacitor on Internal Voltage Regulator (VCAP/VDDCORE)

A low-ESR ( $< 5 \text{ Ohms}$ ) capacitor is required on the VCAP/VDDCORE pin, which is used to stabilize the voltage regulator output voltage. The VCAP/VDDCORE pin must not be connected to VDD, and must have a capacitor between 4.7  $\mu\text{F}$  and 10  $\mu\text{F}$ , 16V connected to ground. The type can be ceramic or tantalum. Refer to **Section 26.0 “Electrical Characteristics”** for additional information.

The placement of this capacitor should be close to the VCAP/VDDCORE. It is recommended that the trace length not exceed one-quarter inch (6 mm). Refer to **Section 23.2 “On-Chip Voltage Regulator”** for details.

## 2.4 Master Clear (MCLR) Pin

The MCLR pin provides for two specific device functions:

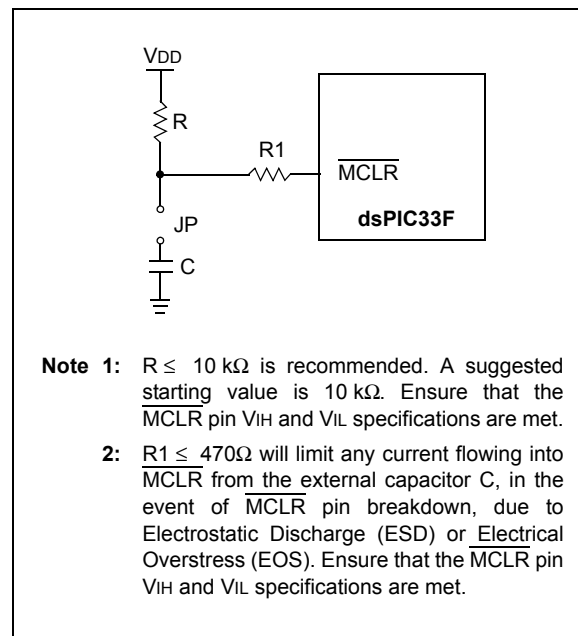
- Device Reset
- Device programming and debugging

During device programming and debugging, the resistance and capacitance that can be added to the pin must be considered. Device programmers and debuggers drive the MCLR pin. Consequently, specific voltage levels ( $V_{IH}$  and  $V_{IL}$ ) and fast signal transitions must not be adversely affected. Therefore, specific values of R and C will need to be adjusted based on the application and PCB requirements.

For example, as shown in Figure 2-2, it is recommended that the capacitor C, be isolated from the MCLR pin during programming and debugging operations.

Place the components shown in Figure 2-2 within one-quarter inch (6 mm) from the MCLR pin.

**FIGURE 2-2: EXAMPLE OF MCLR PIN CONNECTIONS**



- Note 1:**  $R \leq 10 \text{ k}\Omega$  is recommended. A suggested starting value is 10  $\text{k}\Omega$ . Ensure that the MCLR pin  $V_{IH}$  and  $V_{IL}$  specifications are met.
- 2:**  $R1 \leq 470\Omega$  will limit any current flowing into MCLR from the external capacitor C, in the event of MCLR pin breakdown, due to Electrostatic Discharge (ESD) or Electrical Overstress (EOS). Ensure that the MCLR pin  $V_{IH}$  and  $V_{IL}$  specifications are met.

**TABLE 4-23: ECAN2 REGISTER MAP WHEN C2CTRL1.WIN = 0 OR 1 FOR dsPIC33FJXXXMC708/710 DEVICES**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
C2CTRL1	0500	—	—	CSIDL	ABAT	—	REQOP<2:0>			OPMODE<2:0>			—	CANCAP	—	—	WIN	0480
C2CTRL2	0502	—	—	—	—	—	—	—	—	—	—	—	DNCNT<4:0>					0000
C2VEC	0504	—	—	—	FILHIT<4:0>					—	ICODE<6:0>							0000
C2FCTRL	0506	DMABS<2:0>			—	—	—	—	—	—	—	—	FSA<4:0>					0000
C2FIFO	0508	—	—	FBP<5:0>						—	—	FNRB<5:0>						0000
C2INTF	050A	—	—	TXBO	TXBP	RXBP	TXWAR	RXWAR	EWARN	IVRIF	WAKIF	ERRIF	—	FIFOIF	RBOVIF	RBIF	TBIF	0000
C2INTE	050C	—	—	—	—	—	—	—	—	IVRIE	WAKIE	ERRIE	—	FIFOIE	RBOVIE	RBIE	TBIE	0000
C2EC	050E	TERRCNT<7:0>								RERRCNT<7:0>								0000
C2CFG1	0510	—	—	—	—	—	—	—	—	SJW<1:0>		BRP<5:0>						0000
C2CFG2	0512	—	WAKFIL	—	—	—	SEG2PH<2:0>			SEG2PHTS	SAM	SEG1PH<2:0>			PRSEG<2:0>			0000
C2FEN1	0514	FLTEN15	FLTEN14	FLTEN13	FLTEN12	FLTEN11	FLTEN10	FLTEN9	FLTEN8	FLTEN7	FLTEN6	FLTEN5	FLTEN4	FLTEN3	FLTEN2	FLTEN1	FLTEN0	FFFF
C2FMSKSEL1	0518	F7MSK<1:0>		F6MSK<1:0>		F5MSK<1:0>		F4MSK<1:0>		F3MSK<1:0>		F2MSK<1:0>		F1MSK<1:0>		F0MSK<1:0>		0000
C2FMSKSEL2	051A	F15MSK<1:0>		F14MSK<1:0>		F13MSK<1:0>		F12MSK<1:0>		F11MSK<1:0>		F10MSK<1:0>		F9MSK<1:0>		F8MSK<1:0>		0000

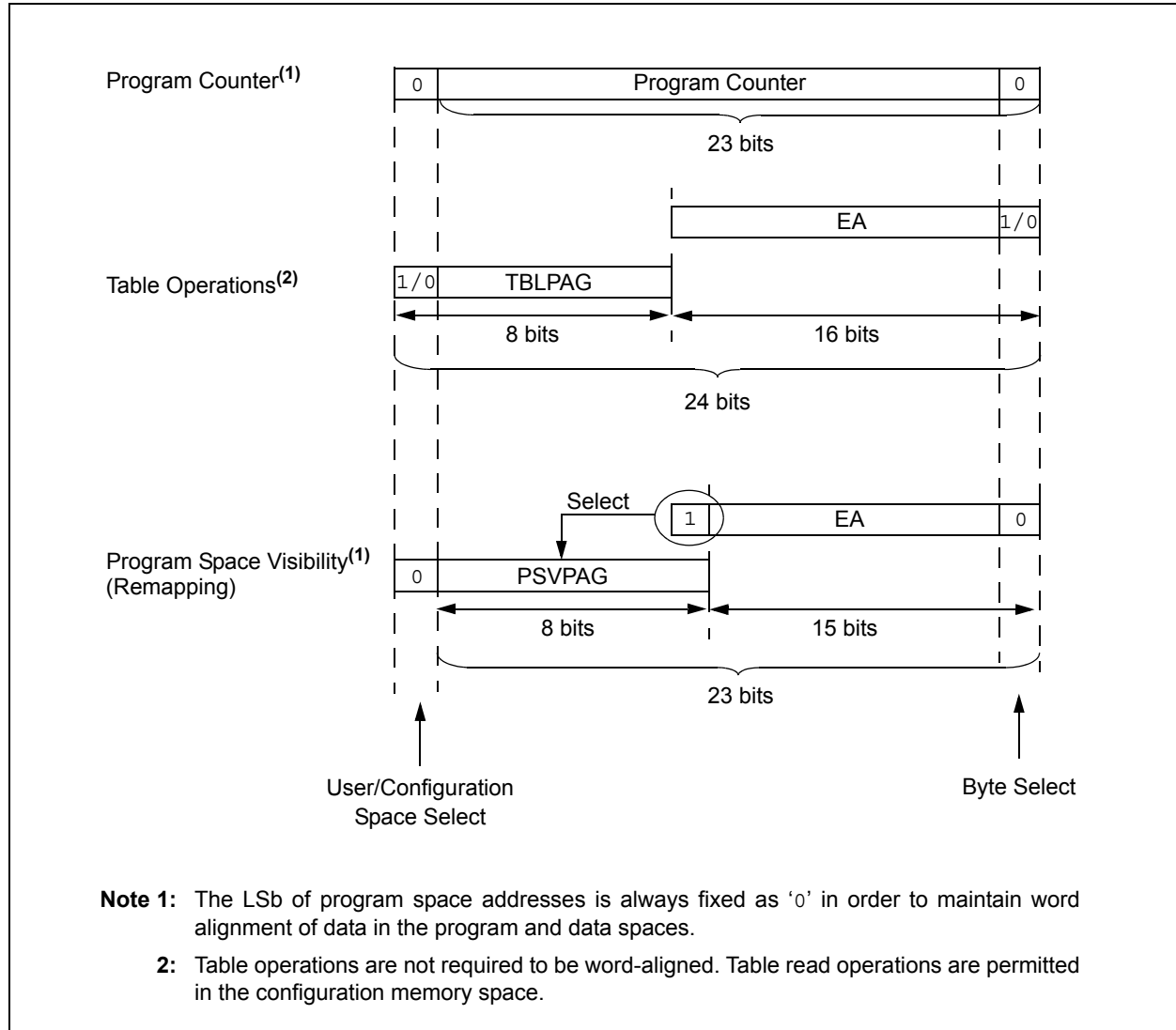
**Legend:** — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**TABLE 4-24: ECAN2 REGISTER MAP WHEN C2CTRL1.WIN = 0 FOR dsPIC33FJXXXMC708/710 DEVICES**

File Name	Addr	Bit 15	Bit 14	Bit 13	Bit 12	Bit 11	Bit 10	Bit 9	Bit 8	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	All Resets
	0500-051E	See definition when WIN = x																
C2RXFUL1	0520	RXFUL15	RXFUL14	RXFUL13	RXFUL12	RXFUL11	RXFUL10	RXFUL9	RXFUL8	RXFUL7	RXFUL6	RXFUL5	RXFUL4	RXFUL3	RXFUL2	RXFUL1	RXFUL0	0000
C2RXFUL2	0522	RXFUL31	RXFUL30	RXFUL29	RXFUL28	RXFUL27	RXFUL26	RXFUL25	RXFUL24	RXFUL23	RXFUL22	RXFUL21	RXFUL20	RXFUL19	RXFUL18	RXFUL17	RXFUL16	0000
C2RXOVF1	0528	RXOVF15	RXOVF14	RXOVF13	RXOVF12	RXOVF11	RXOVF10	RXOVF09	RXOVF08	RXOVF7	RXOVF6	RXOVF5	RXOVF4	RXOVF3	RXOVF2	RXOVF1	RXOVF0	0000
C2RXOVF2	052A	RXOVF31	RXOVF30	RXOVF29	RXOVF28	RXOVF27	RXOVF26	RXOVF25	RXOVF24	RXOVF23	RXOVF22	RXOVF21	RXOVF20	RXOVF19	RXOVF18	RXOVF17	RXOVF16	0000
C2TR01CON	0530	TXEN1	TX ABAT1	TX LARB1	TX ERR1	TX REQ1	RTREN1	TX1PRI<1:0>		TXEN0	TX ABAT0	TX LARB0	TX ERR0	TX REQ0	RTREN0	TX0PRI<1:0>		0000
C2TR23CON	0532	TXEN3	TX ABAT3	TX LARB3	TX ERR3	TX REQ3	RTREN3	TX3PRI<1:0>		TXEN2	TX ABAT2	TX LARB2	TX ERR2	TX REQ2	RTREN2	TX2PRI<1:0>		0000
C2TR45CON	0534	TXEN5	TX ABAT5	TX LARB5	TX ERR5	TX REQ5	RTREN5	TX5PRI<1:0>		TXEN4	TX ABAT4	TX LARB4	TX ERR4	TX REQ4	RTREN4	TX4PRI<1:0>		0000
C2TR67CON	0536	TXEN7	TX ABAT7	TX LARB7	TX ERR7	TX REQ7	RTREN7	TX7PRI<1:0>		TXEN6	TX ABAT6	TX LARB6	TX ERR6	TX REQ6	RTREN6	TX6PRI<1:0>		xxxx
C2RXD	0540	Recieved Data Word																xxxx
C2TXD	0542	Transmit Data Word																xxxx

**Legend:** x = unknown value on Reset, — = unimplemented, read as '0'. Reset values are shown in hexadecimal.

**FIGURE 4-9: DATA ACCESS FROM PROGRAM SPACE ADDRESS GENERATION**



# dsPIC33FJXXMCMC06/X08/X10

## REGISTER 7-24: IPC9: INTERRUPT PRIORITY CONTROL REGISTER 9

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC5IP<2:0>			—	IC4IP<2:0>		
bit 15				bit 8			

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	IC3IP<2:0>			—	DMA3IP<2:0>		
bit 7				bit 0			

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **IC5IP<2:0>:** Input Capture Channel 5 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **IC4IP<2:0>:** Input Capture Channel 4 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **IC3IP<2:0>:** Input Capture Channel 3 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **DMA3IP<2:0>:** DMA Channel 3 Data Transfer Complete Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

# dsPIC33FJXXXMCX06/X08/X10

## REGISTER 7-27: IPC12: INTERRUPT PRIORITY CONTROL REGISTER 12

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	T8IP<2:0>			—	MI2C2IP<2:0>		
bit 15				bit 8			

U-0	R/W-1	R/W-0	R/W-0	U-0	R/W-1	R/W-0	R/W-0
—	SI2C2IP<2:0>			—	T7IP<2:0>		
bit 7				bit 0			

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15 **Unimplemented:** Read as '0'

bit 14-12 **T8IP<2:0>:** Timer8 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 11 **Unimplemented:** Read as '0'

bit 10-8 **MI2C2IP<2:0>:** I2C2 Master Events Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **SI2C2IP<2:0>:** I2C2 Slave Events Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

bit 3 **Unimplemented:** Read as '0'

bit 2-0 **T7IP<2:0>:** Timer7 Interrupt Priority bits

111 = Interrupt is priority 7 (highest priority interrupt)

•  
•  
•

001 = Interrupt is priority 1

000 = Interrupt source is disabled

# dsPIC33FJXXMCMC06/X08/X10

## REGISTER 9-3: PLLFBD: PLL FEEDBACK DIVISOR REGISTER

U-0	U-0	U-0	U-0	U-0	U-0	U-0	R/W-0 <sup>(1)</sup>
—	—	—	—	—	—	—	PLLDIV<8>
bit 15							bit 8

R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-0	R/W-0
PLLDIV<7:0>							
bit 7							bit 0

<b>Legend:</b>			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 15-9	<b>Unimplemented:</b> Read as '0'
bit 8-0	<b>PLLDIV&lt;8:0&gt;:</b> PLL Feedback Divisor bits (also denoted as 'M', PLL multiplier)
	000000000 = 2
	000000001 = 3
	000000010 = 4
	•
	•
	•
	000110000 = 50 (default)
	•
	•
	•
	111111111 = 513

# dsPIC33FJXXMCX06/X08/X10

## 11.0 I/O PORTS

**Note:** This data sheet summarizes the features of the dsPIC33FJXXMCX06/X08/X10 family of devices. However, it is not intended to be a comprehensive reference source. To complement the information in this data sheet, refer to **Section 10. “I/O Ports”** (DS70193) in the “dsPIC33F Family Reference Manual”, which is available from the Microchip web site ([www.microchip.com](http://www.microchip.com)).

All of the device pins (except VDD, VSS,  $\overline{\text{MCLR}}$  and OSC1/CLKIN) are shared between the peripherals and the parallel I/O ports. All I/O input ports feature Schmitt Trigger inputs for improved noise immunity.

### 11.1 Parallel I/O (PIO) Ports

A parallel I/O port that shares a pin with a peripheral is, in general, subservient to the peripheral. The peripheral's output buffer data and control signals are provided to a pair of multiplexers. The multiplexers select whether the peripheral or the associated port has ownership of the output data and control signals of the I/O pin. The logic also prevents “loop through,” in which a port's digital output can drive the input of a peripheral that shares the same pin. Figure 11-1 shows how ports are shared with other peripherals and the associated I/O pin to which they are connected.

When a peripheral is enabled and actively driving an associated pin, the use of the pin as a general purpose output pin is disabled. The I/O pin may be read, but the output driver for the parallel port bit will be disabled. If a peripheral is enabled but the peripheral is not actively driving a pin, that pin may be driven by a port.

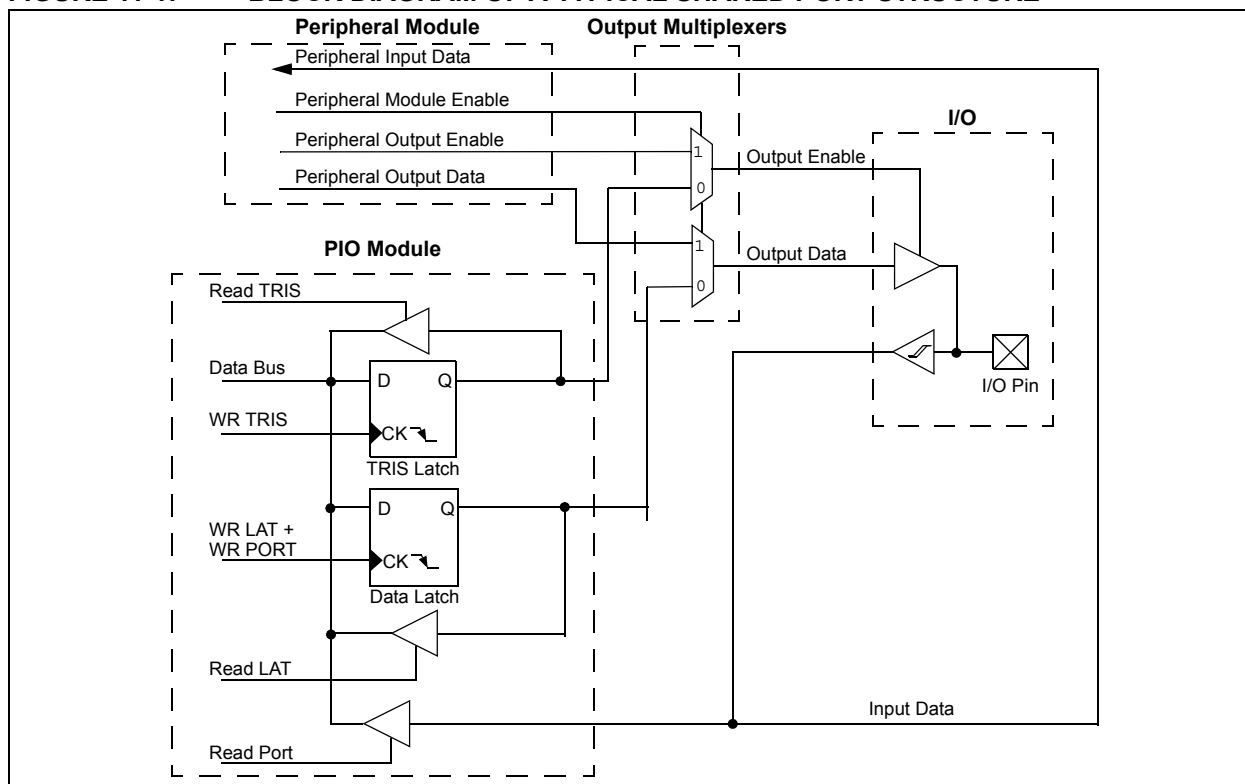
All port pins have three registers directly associated with their operation as digital I/O. The data direction register (TRISx) determines whether the pin is an input or an output. If the data direction bit is a ‘1’, then the pin is an input. All port pins are defined as inputs after a Reset. Reads from the latch (LATx), read the latch. Writes to the latch, write the latch. Reads from the port (PORTx), read the port pins, while writes to the port pins, write the latch.

Any bit and its associated data and control registers that are not valid for a particular device will be disabled. That means the corresponding LATx and TRISx registers and the port pins will read as zeros.

When a pin is shared with another peripheral or function that is defined as an input only, it is nevertheless regarded as a dedicated port because there is no other competing source of outputs. An example is the INT4 pin.

**Note:** The voltage on a digital input pin can be between -0.3V to 5.6V.

**FIGURE 11-1: BLOCK DIAGRAM OF A TYPICAL SHARED PORT STRUCTURE**





# dsPIC33FJXXXMCX06/X08/X10

## REGISTER 16-9: PxFLTAcon: FAULT A CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
FAOV4H	FAOV4L	FAOV3H	FAOV3L	FAOV2H	FAOV2L	FAOV1H	FAOV1L
bit 15						bit 8	

R/W-0	U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
FLTAM	—	—	—	FAEN4	FAEN3	FAEN2	FAEN1
bit 7						bit 0	

### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

-n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

bit 15-8 **FAOVxH<4:1>:FAOVxL<4:1>**: Fault Input A PWM Override Value bits

1 = The PWM output pin is driven active on an external Fault input event

0 = The PWM output pin is driven inactive on an external Fault input event

bit 7 **FLTAM**: Fault A Mode bit

1 = The Fault A input pin functions in the Cycle-by-Cycle mode

0 = The Fault A input pin latches all control pins to the states programmed in FLTAcon<15:8>

bit 6-4 **Unimplemented**: Read as '0'

bit 3 **FAEN4**: Fault Input A Enable bit

1 = PWM4H/PWM4L pin pair is controlled by Fault Input A

0 = PWM4H/PWM4L pin pair is not controlled by Fault Input A

bit 2 **FAEN3**: Fault Input A Enable bit

1 = PWM3H/PWM3L pin pair is controlled by Fault Input A

0 = PWM3H/PWM3L pin pair is not controlled by Fault Input A

bit 1 **FAEN2**: Fault Input A Enable bit

1 = PWM2H/PWM2L pin pair is controlled by Fault Input A

0 = PWM2H/PWM2L pin pair is not controlled by Fault Input A

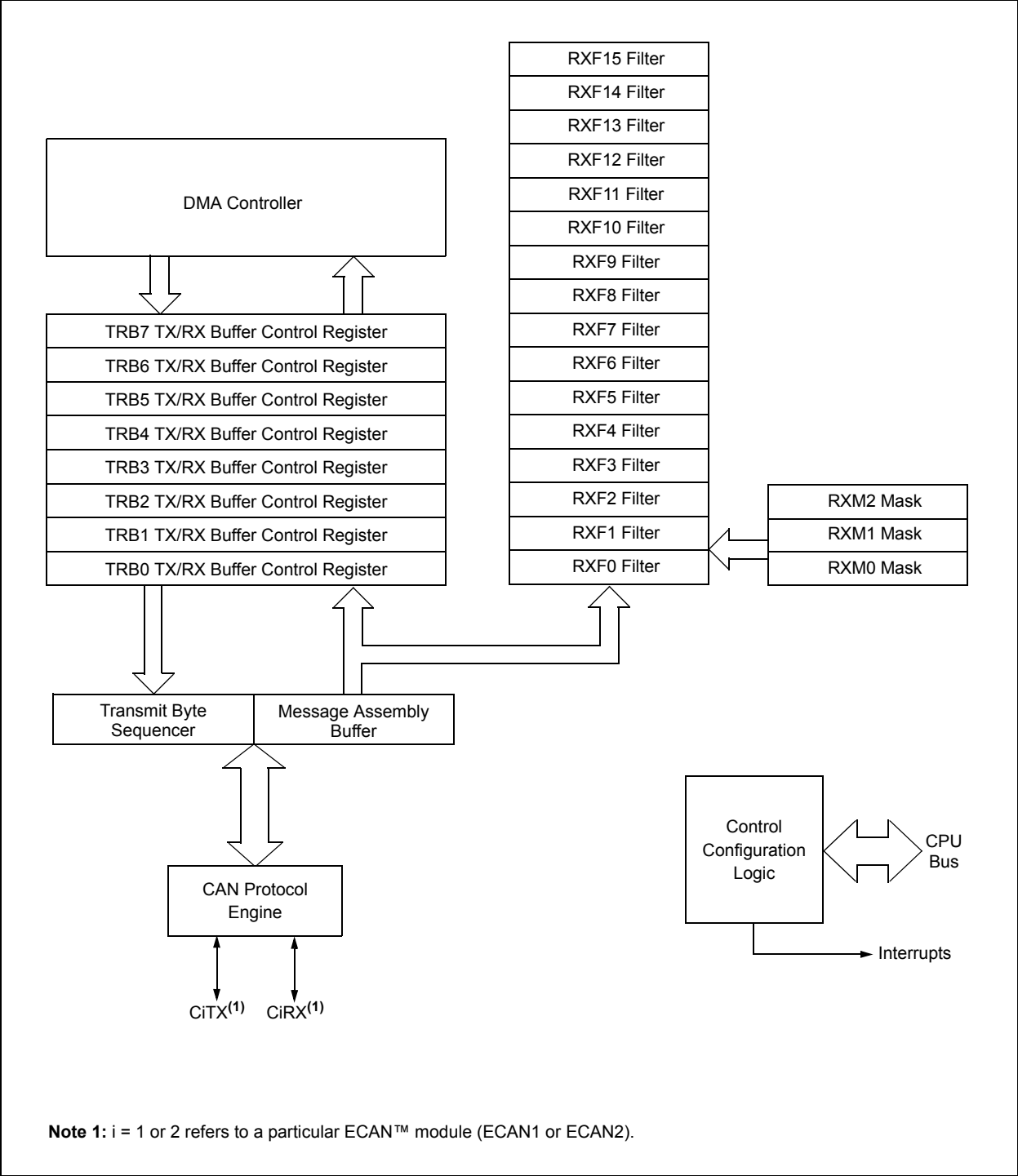
bit 0 **FAEN1**: Fault Input A Enable bit

1 = PWM1H/PWM1L pin pair is controlled by Fault Input A

0 = PWM1H/PWM1L pin pair is not controlled by Fault Input A

# dsPIC33FJXXXMCX06/X08/X10

FIGURE 21-1: ECAN™ MODULE BLOCK DIAGRAM



# dsPIC33FJXXMCX06/X08/X10

**REGISTER 21-16: CiRXFnSID: ECAN™ ACCEPTANCE FILTER n STANDARD IDENTIFIER (n = 0, 1, ...,15)**

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
SID10	SID9	SID8	SID7	SID6	SID5	SID4	SID3
bit 15							bit 8

R/W-x	R/W-x	R/W-x	U-0	R/W-x	U-0	R/W-x	R/W-x
SID2	SID1	SID0	—	EXIDE	—	EID17	EID16
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

- bit 15-5      **SID<10:0>**: Standard Identifier bits  
1 = Message address bit SIDx must be '1' to match filter  
0 = Message address bit SIDx must be '0' to match filter
- bit 4      **Unimplemented**: Read as '0'
- bit 3      **EXIDE**: Extended Identifier Enable bit  
If MIDE = 1 then:  
1 = Match only messages with extended identifier addresses  
0 = Match only messages with standard identifier addresses  
If MIDE = 0 then:  
Ignore EXIDE bit.
- bit 2      **Unimplemented**: Read as '0'
- bit 1-0      **EID<17:16>**: Extended Identifier bits  
1 = Message address bit EIDx must be '1' to match filter  
0 = Message address bit EIDx must be '0' to match filter

**REGISTER 21-17: CiRXFnEID: ECAN™ ACCEPTANCE FILTER n EXTENDED IDENTIFIER (n = 0, 1, ..., 15)**

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
EID15	EID14	EID13	EID12	EID11	EID10	EID9	EID8
bit 15							bit 8

R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x	R/W-x
EID7	EID6	EID5	EID4	EID3	EID2	EID1	EID0
bit 7							bit 0

**Legend:**

R = Readable bit                      W = Writable bit                      U = Unimplemented bit, read as '0'  
-n = Value at POR                      '1' = Bit is set                      '0' = Bit is cleared                      x = Bit is unknown

- bit 15-0      **EID<15:0>**: Extended Identifier bits  
1 = Message address bit EIDx must be '1' to match filter  
0 = Message address bit EIDx must be '0' to match filter

# dsPIC33FJXXXMCX06/X08/X10

**TABLE 23-2: dsPIC33FJXXXMCX06/X08/X10 CONFIGURATION BITS DESCRIPTION (CONTINUED)**

Bit Field	Register	Description
HPOL	FPOR	Motor Control PWM High Side Polarity bit 1 = PWM module high side output pins have active-high output polarity 0 = PWM module high side output pins have active-low output polarity
LPOL	FPOR	Motor Control PWM Low Side Polarity bit 1 = PWM module low side output pins have active-high output polarity 0 = PWM module low side output pins have active-low output polarity
FPWRT<2:0>	FPOR	Power-on Reset Timer Value Select bits 111 = PWRT = 128 ms 110 = PWRT = 64 ms 101 = PWRT = 32 ms 100 = PWRT = 16 ms 011 = PWRT = 8 ms 010 = PWRT = 4 ms 001 = PWRT = 2 ms 000 = PWRT = Disabled
JTAGEN	FICD	JTAG Enable bits 1 = JTAG enabled 0 = JTAG disabled
ICS<1:0>	FICD	ICD Communication Channel Select bits 11 = Communicate on PGEC1 and PGED1 10 = Communicate on PGEC2 and PGED2 01 = Communicate on PGEC3 and PGED3 00 = Reserved

# dsPIC33FJXXXMCX06/X08/X10

---

## 23.5 JTAG Interface

dsPIC33FJXXXMCX06/X08/X10 devices implement a JTAG interface, which supports boundary scan device testing, as well as in-circuit programming. Detailed information on the interface will be provided in future revisions of the document.

## 23.6 Code Protection and CodeGuard™ Security

The dsPIC33FJXXXMCX06/X08/X10 devices offer the advanced implementation of CodeGuard™ Security. CodeGuard Security enables multiple parties to securely share resources (memory, interrupts and peripherals) on a single chip. This feature helps protect individual Intellectual Property in collaborative system designs.

When coupled with software encryption libraries, CodeGuard Security can be used to securely update Flash even when multiple IP are resident on the single chip. The code protection features vary depending on the actual device implemented. The following sections provide an overview of these features.

The code protection features are controlled by the Configuration registers: FBS, FSS and FGS.

**Note:** Refer to **Section 23. “CodeGuard™ Security”** (DS70199) in the “*dsPIC33F Family Reference Manual*” for further information on usage, configuration and operation of CodeGuard Security.

## 23.7 In-Circuit Serial Programming

dsPIC33FJXXXMCX06/X08/X10 family digital signal controllers can be serially programmed while in the end application circuit. This is simply done with two lines for clock and data and three other lines for power, ground and the programming sequence. This allows customers to manufacture boards with unprogrammed devices and then program the digital signal controller just before shipping the product. This also allows the most recent firmware or a custom firmware, to be programmed. Please refer to the “*dsPIC33F/PIC24H Flash Programming Specification*” (DS70152) document for details about ICSP.

Any one out of three pairs of programming clock/data pins may be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- PGEC3 and PGED3

## 23.8 In-Circuit Debugger

When MPLAB® ICD 2 is selected as a debugger, the in-circuit debugging functionality is enabled. This function allows simple debugging functions when used with MPLAB IDE. Debugging functionality is controlled through the PGECx (Emulation/Debug Clock) and PGEDx (Emulation/Debug Data) pin functions.

Any one out of three pairs of debugging clock/data pins may be used:

- PGEC1 and PGED1
- PGEC2 and PGED2
- PGEC3 and PGED3

To use the in-circuit debugger function of the device, the design must implement ICSP connections to MCLR, VDD, VSS and the PGECx/PGEDx pin pair. In addition, when the feature is enabled, some of the resources are not available for general use. These resources include the first 80 bytes of data RAM and two I/O pins.

# dsPIC33FJXXXMCX06/X08/X10

**TABLE 24-2: INSTRUCTION SET OVERVIEW (CONTINUED)**

Base Instr #	Assembly Mnemonic	Assembly Syntax	Description	# of Words	# of Cycles	Status Flags Affected
66	RRNC	RRNC f	f = Rotate Right (No Carry) f	1	1	N,Z
		RRNC f, WREG	WREG = Rotate Right (No Carry) f	1	1	N,Z
		RRNC Ws, Wd	Wd = Rotate Right (No Carry) Ws	1	1	N,Z
67	SAC	SAC Acc, #Slit4, Wdo	Store Accumulator	1	1	None
		SAC.R Acc, #Slit4, Wdo	Store Rounded Accumulator	1	1	None
68	SE	SE Ws, Wnd	Wnd = sign-extended Ws	1	1	C,N,Z
69	SETM	SETM f	f = 0xFFFF	1	1	None
		SETM WREG	WREG = 0xFFFF	1	1	None
		SETM Ws	Ws = 0xFFFF	1	1	None
70	SFTAC	SFTAC Acc, Wn	Arithmetic Shift Accumulator by (Wn)	1	1	OA,OB,OAB,SA,SB,SAB
		SFTAC Acc, #Slit6	Arithmetic Shift Accumulator by Slit6	1	1	OA,OB,OAB,SA,SB,SAB
71	SL	SL f	f = Left Shift f	1	1	C,N,OV,Z
		SL f, WREG	WREG = Left Shift f	1	1	C,N,OV,Z
		SL Ws, Wd	Wd = Left Shift Ws	1	1	C,N,OV,Z
		SL Wb, Wns, Wnd	Wnd = Left Shift Wb by Wns	1	1	N,Z
		SL Wb, #lit5, Wnd	Wnd = Left Shift Wb by lit5	1	1	N,Z
72	SUB	SUB Acc	Subtract Accumulators	1	1	OA,OB,OAB,SA,SB,SAB
		SUB f	f = f – WREG	1	1	C,DC,N,OV,Z
		SUB f, WREG	WREG = f – WREG	1	1	C,DC,N,OV,Z
		SUB #lit10, Wn	Wn = Wn – lit10	1	1	C,DC,N,OV,Z
		SUB Wb, Ws, Wd	Wd = Wb – Ws	1	1	C,DC,N,OV,Z
		SUB Wb, #lit5, Wd	Wd = Wb – lit5	1	1	C,DC,N,OV,Z
73	SUBB	SUBB f	f = f – WREG – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBB f, WREG	WREG = f – WREG – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBB #lit10, Wn	Wn = Wn – lit10 – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBB Wb, Ws, Wd	Wd = Wb – Ws – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBB Wb, #lit5, Wd	Wd = Wb – lit5 – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
74	SUBR	SUBR f	f = WREG – f	1	1	C,DC,N,OV,Z
		SUBR f, WREG	WREG = WREG – f	1	1	C,DC,N,OV,Z
		SUBR Wb, Ws, Wd	Wd = Ws – Wb	1	1	C,DC,N,OV,Z
		SUBR Wb, #lit5, Wd	Wd = lit5 – Wb	1	1	C,DC,N,OV,Z
75	SUBBR	SUBBR f	f = WREG – f – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBBR f, WREG	WREG = WREG – f – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBBR Wb, Ws, Wd	Wd = Ws – Wb – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
		SUBBR Wb, #lit5, Wd	Wd = lit5 – Wb – ( $\overline{C}$ )	1	1	C,DC,N,OV,Z
76	SWAP	SWAP.b Wn	Wn = nibble swap Wn	1	1	None
		SWAP Wn	Wn = byte swap Wn	1	1	None
77	TBLRDH	TBLRDH Ws, Wd	Read Prog<23:16> to Wd<7:0>	1	2	None
78	TBLRDL	TBLRDL Ws, Wd	Read Prog<15:0> to Wd	1	2	None
79	TBLWTH	TBLWTH Ws, Wd	Write Ws<7:0> to Prog<23:16>	1	2	None
80	TBLWTL	TBLWTL Ws, Wd	Write Ws to Prog<15:0>	1	2	None
81	ULNK	ULNK	Unlink Frame Pointer	1	1	None
82	XOR	XOR f	f = f .XOR. WREG	1	1	N,Z
		XOR f, WREG	WREG = f .XOR. WREG	1	1	N,Z
		XOR #lit10, Wn	Wd = lit10 .XOR. Wd	1	1	N,Z
		XOR Wb, Ws, Wd	Wd = Wb .XOR. Ws	1	1	N,Z
		XOR Wb, #lit5, Wd	Wd = Wb .XOR. lit5	1	1	N,Z
83	ZE	ZE Ws, Wnd	Wnd = Zero-extend Ws	1	1	C,Z,N

# dsPIC33FJXXMCMX06/X08/X10

**TABLE 26-6: DC CHARACTERISTICS: IDLE CURRENT (IDLE)**

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial		
Parameter No.	Typical <sup>(1)</sup>	Max	Units	Conditions	
Idle Current (IDLE): Core OFF Clock ON Base Current <sup>(2)</sup>					
DC40d	3	25	mA	-40°C	3.3V  10 MIPS
DC40a	3	25	mA	+25°C	
DC40b	3	25	mA	+85°C	
DC41d	4	25	mA	-40°C	3.3V  16 MIPS
DC41a	5	25	mA	+25°C	
DC41b	6	25	mA	+85°C	
DC42d	8	25	mA	-40°C	3.3V  20 MIPS
DC42a	9	25	mA	+25°C	
DC42b	10	25	mA	+85°C	
DC43a	15	25	mA	+25°C	3.3V  30 MIPS
DC43d	15	25	mA	-40°C	
DC43b	15	25	mA	+85°C	
DC44d	16	25	mA	-40°C	3.3V  40 MIPS
DC44a	16	25	mA	+25°C	
DC44b	16	25	mA	+85°C	

**Note 1:** Data in “Typical” column is at 3.3V, 25°C unless otherwise stated.

**2:** Base IDLE current is measured with core off, clock on and all modules turned off. Peripheral Module Disable SFR registers are zeroed. All I/O pins are configured as inputs and pulled to Vss.

# dsPIC33FJXXXMCX06/X08/X10

**TABLE 26-10: DC CHARACTERISTICS: I/O PIN OUTPUT SPECIFICATIONS**

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial				
Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Conditions
DO10 DO16	VOL	<b>Output Low Voltage</b>					
		I/O ports	—	—	0.4	V	$I_{OL} = 2\text{mA}$ , $V_{DD} = 3.3\text{V}$
		OSC2/CLKO	—	—	0.4	V	$I_{OL} = 2\text{mA}$ , $V_{DD} = 3.3\text{V}$
DO20 DO26	VOH	<b>Output High Voltage</b>					
		I/O ports	2.40	—	—	V	$I_{OH} = -2.3\text{mA}$ , $V_{DD} = 3.3\text{V}$
		OSC2/CLKO	2.41	—	—	V	$I_{OH} = -1.3\text{mA}$ , $V_{DD} = 3.3\text{V}$

**TABLE 26-11: ELECTRICAL CHARACTERISTICS: BOR**

DC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial				
Param No.	Symbol	Characteristic	Min <sup>(1)</sup>	Typ	Max <sup>(1)</sup>	Units	Conditions
BO10	VBOR	BOR Event on VDD transition high-to-low BOR event is tied to VDD core voltage decrease	2.40	—	2.55	V	—

**Note 1:** Parameters are for design guidance only and are not tested in manufacturing.



# dsPIC33FJXXXMCX06/X08/X10

**TABLE 26-17: PLL CLOCK TIMING SPECIFICATIONS (V<sub>DD</sub> = 3.0V TO 3.6V)**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ T <sub>A</sub> ≤ +85°C for Industrial					
Param No.	Symbol	Characteristic	Min	Typ <sup>(1)</sup>	Max	Units	Conditions
OS50	FPLLI	PLL Voltage Controlled Oscillator (VCO) Input Frequency Range <sup>(2)</sup>	0.8	—	8.0	MHz	ECPLL, HSPLL, XTPLL modes
OS51	FSYS	On-Chip VCO System Frequency	100	—	200	MHz	—
OS52	TLOCK	PLL Start-up Time (Lock Time)	0.9	1.5	3.1	ms	—
OS53	DCLK	CLKO Stability (Jitter)	-3.0	0.5	3.0	%	Measured over 100 ms period

**Note 1:** Data in “Typ” column is at 3.3V, 25°C unless otherwise stated.

**TABLE 26-18: AC CHARACTERISTICS: INTERNAL FRC ACCURACY**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature                      -40°C ≤ TA ≤ +85°C for Industrial					
Param No.	Characteristic	Min	Typ	Max	Units	Conditions	
	Internal FRC Accuracy @ FRC Frequency = 7.37 MHz <sup>(1,2)</sup>						
F20	FRC	-2	—	+2	%	-40°C ≤ TA ≤ +85°C	VDD = 3.0-3.6V

**Note 1:** Frequency calibrated at 25°C and 3.3V. TUN bits can be used to compensate for temperature drift.

**2:** FRC set to initial frequency of 7.37 MHz (+1-2%) at 25° C FRC.

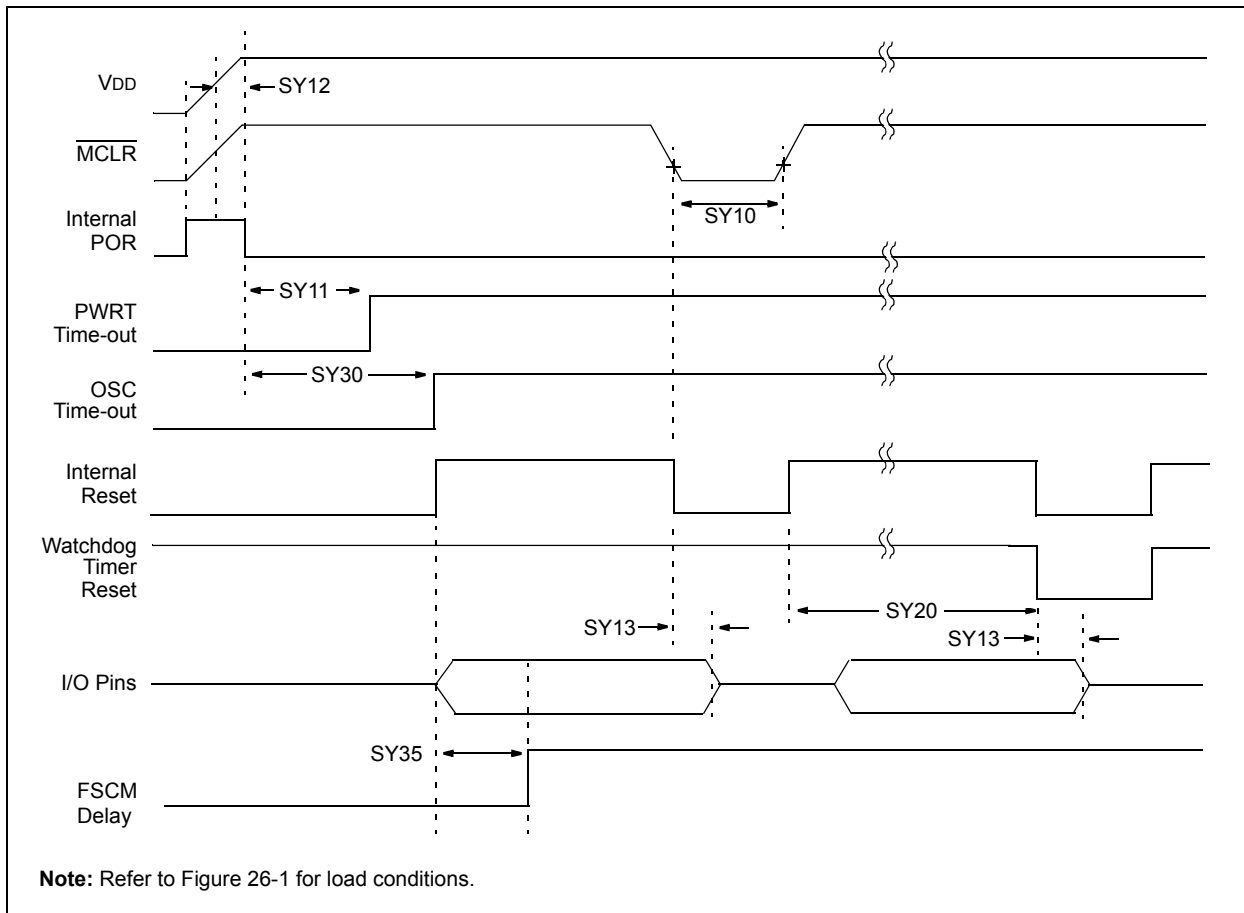
**TABLE 26-19: INTERNAL LPRC ACCURACY**

AC CHARACTERISTICS		Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature    -40°C ≤ TA ≤ +85°C for Industrial					
Param No.	Characteristic	Min	Typ	Max	Units	Conditions	
	LPRC @ 32.768 kHz <sup>(1)</sup>						
F21		-20	±6	+20	%	-40°C ≤ TA ≤ +85°C	VDD = 3.0-3.6V

**Note 1:** Change of LPRC frequency as V<sub>DD</sub> changes.

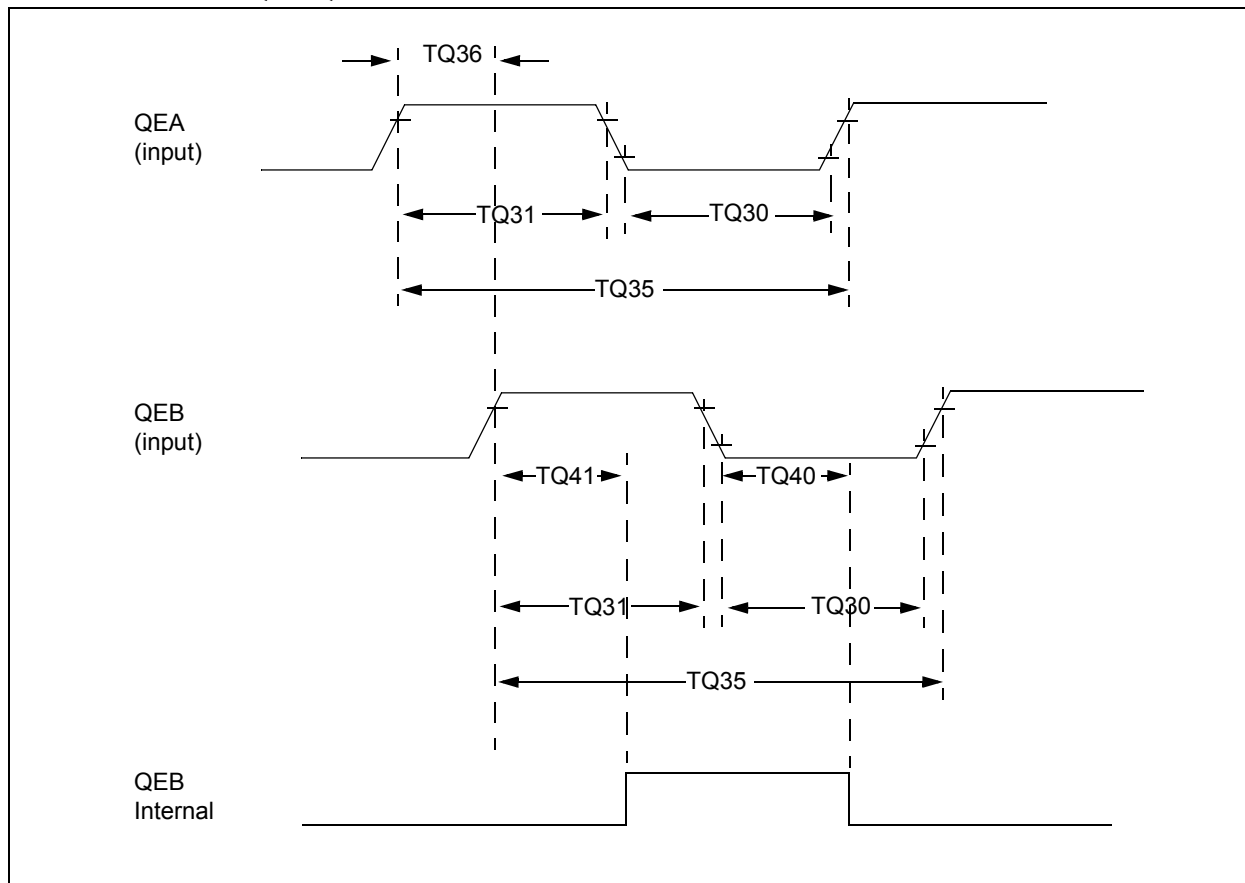
# dsPIC33FJXXXMCX06/X08/X10

**FIGURE 26-4: RESET, WATCHDOG TIMER, OSCILLATOR START-UP TIMER AND POWER-UP TIMER TIMING CHARACTERISTICS**



# dsPIC33FJXXMCX06/X08/X10

**FIGURE 26-11: QEA/QEB INPUT CHARACTERISTICS**



**TABLE 26-29: QUADRATURE DECODER TIMING REQUIREMENTS**

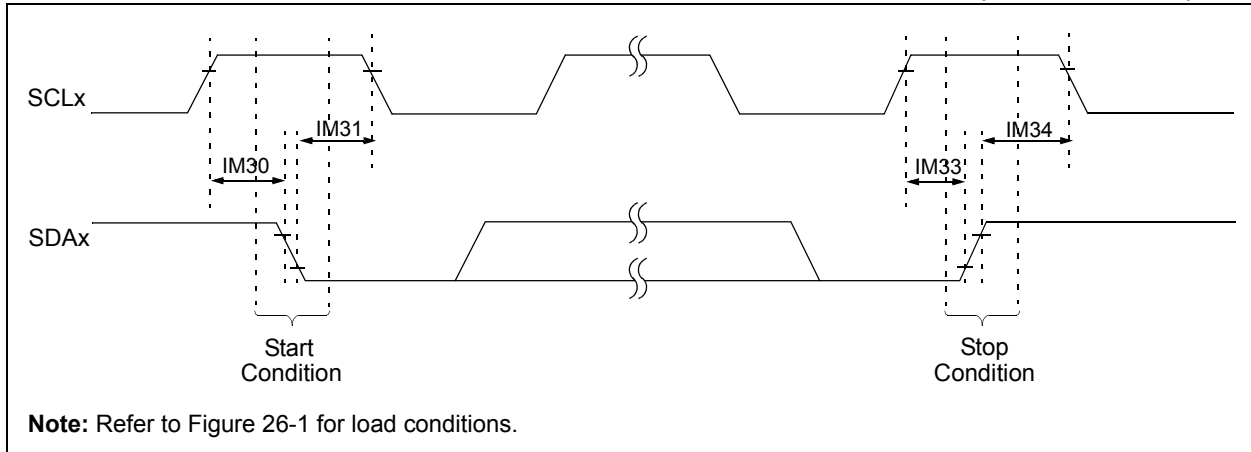
AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial			
Param No.	Symbol	Characteristic <sup>(1)</sup>	Typ <sup>(2)</sup>	Max	Units	Conditions
TQ30	TQuL	Quadrature Input Low Time	6 Tcy	—	ns	—
TQ31	TQuH	Quadrature Input High Time	6 Tcy	—	ns	—
TQ35	TQuIN	Quadrature Input Period	12 Tcy	—	ns	—
TQ36	TQuP	Quadrature Phase Period	3 Tcy	—	ns	—
TQ40	TQuFL	Filter Time to Recognize Low, with Digital Filter	3 * N * Tcy	—	ns	N = 1, 2, 4, 16, 32, 64, 128 and 256 ( <b>Note 3</b> )
TQ41	TQuFH	Filter Time to Recognize High, with Digital Filter	3 * N * Tcy	—	ns	N = 1, 2, 4, 16, 32, 64, 128 and 256 ( <b>Note 3</b> )

**Note 1:** These parameters are characterized but not tested in manufacturing.

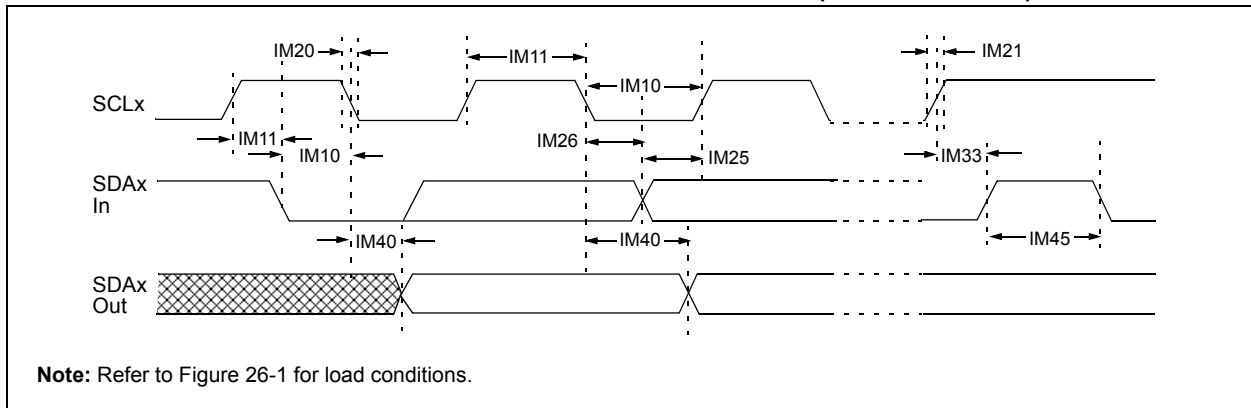
**2:** Data in “Typ” column is at 3.3V, 25°C unless otherwise stated.

**3:** N = Index Channel Digital Filter Clock Divide Select bits. Refer to **Section 15. “Quadrature Encoder Interface (QEI)”** (DS70208) in the “dsPIC33F Family Reference Manual”.

**FIGURE 26-18: I2Cx BUS START/STOP BITS TIMING CHARACTERISTICS (MASTER MODE)**



**FIGURE 26-19: I2Cx BUS DATA TIMING CHARACTERISTICS (MASTER MODE)**



# dsPIC33FJXXXMCX06/X08/X10

**TABLE 26-42: ADC CONVERSION (12-BIT MODE) TIMING REQUIREMENTS**

AC CHARACTERISTICS			Standard Operating Conditions: 3.0V to 3.6V (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for Industrial				
Param No.	Symbol	Characteristic	Min.	Typ <sup>(1)</sup>	Max.	Units	Conditions
<b>Clock Parameters</b>							
AD50a	TAD	ADC Clock Period	117.6	—	—	ns	—
AD51a	tRC	ADC Internal RC Oscillator Period	—	250	—	ns	—
<b>Conversion Rate</b>							
AD55a	tCONV	Conversion Time	—	14 TAD	—	—	—
AD56a	FCNV	Throughput Rate	—	—	500	ksps	—
AD57a	TSAMP	Sample Time	3.0 TAD	—	—	—	—
<b>Timing Parameters</b>							
AD60a	tPCS	Conversion Start from Sample Trigger <sup>(2)</sup>	2.0 TAD	—	3.0 TAD	—	—
AD61a	tPSS	Sample Start from Setting Sample (SAMP) bit <sup>(2)</sup>	2.0 TAD	—	3.0 TAD	—	—
AD62a	tCSS	Conversion Completion to Sample Start (ASAM = 1) <sup>(2)</sup>	—	0.5 TAD	—	—	—
AD63a	tDPU	Time to Stabilize Analog Stage from ADC Off to ADC On <sup>(2,3)</sup>	—	—	20	μs	—

**Note 1:** These parameters are characterized but not tested in manufacturing.

**2:** Because the sample caps will eventually lose charge, clock rates below 10 kHz can affect linearity performance, especially at elevated temperatures.

**3:** tDPU is the time required for the ADC module to stabilize when it is turned on (AD1CON1<ADON> = 1). During this time, the ADC result is indeterminate.